



600V 8A HYPERFAST RECTIFIER

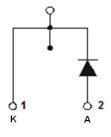
Product Summary

V _{RRM} (V)	I _O (A)	V _F Typ (V) @ +25°C	t _{RR} Typ (ns) @ +25°C	I _{RM} Typ (A) @ +25°C
600	8	2.5	14	1.8

Description and Application

The 8A, 600V DSR8F600PI rectifier is designed specifically for use as a boost diode in power factor correction (PFC) applications. Its soft, very fast switching characteristics make it ideal for use in hard switching and continuous conduction mode (CCM) PFC circuits. It can be used in:

- High Power SMPS
- Servers and Telecom Equipment
- Flat-Panel TVs



Equivalent Circuit

Features and Benefits

- Very Fast t_{RR} Reduces MOSFET PFC Switching Losses
- Soft Switching Ensures Ringing and EMI are Reduced
- Low Q_{RR} and I_{RM} Minimize Boost Diode Recovery Losses
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please <u>contact us</u> or your local Diodes representative.

https://www.diodes.com/quality/product-definitions/

Mechanical Data

- Case: ITO220AC
- Case Material: Molded Plastic, Green Molding Compound.
 UL Flammability Classification Rating 94V-0
- Terminals: Matte Tin Finish Annealed over Copper Leadframe.
 Solderable per MIL-STD-202, Method 208 (§3)
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram Below
- Weight: 1.75grams (Approximate)



Package Pin Out Configuration

Ordering Information (Note 4)

Part Number Case		Packaging
DSR8F600PI	ITO220AC (Type E) ITO220AC (Type HE) (Future Release)	50 Pieces/Tube

Notes:

- 1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



D!! = Manufacturer's Marking
DSR8F600 = Product Type Marking Code
AB = Foundry and Assembly Code
YYWW = Date Code Marking
YY = Last Two Digits of Year (ex: 20 = 2020)
WW = Week (01 to 53)



Maximum Ratings ($@T_A = +25^{\circ}C$, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _{RM}	600	٧
Average Rectified Output Current (Note 6)	lo	8	Α
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I _{FSM}	70	А

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Typical Thermal Resistance, Junction to Case (Note 5)	R _{θJC}	21	°C/W
Typical Thermal Resistance, Junction to Ambient (Note 5)	$R_{\theta JA}$	52	°C/W
Typical Thermal Resistance, Junction to Case (Note 6)	R _{θJC}	5.6	°C/W
Typical Thermal Resistance, Junction to Ambient (Note 6)	R _{θJA}	9.5	°C/W
Storage Temperature Range	T _{STG}	-55 to +175	°C
Maximum Operating Junction Temperature	TJ	+175	°C

Notes:

- 5. Device mounted on FR-4 substrate, 1" × 1", 2oz, single-sided, PC boards with 0.1" × 0.15" copper pad. 6. Device mounted on FR-4 substrate, 0.4" × 0.5", 2oz, single-sided, PC boards with 0.2" × 0.25" copper pad.

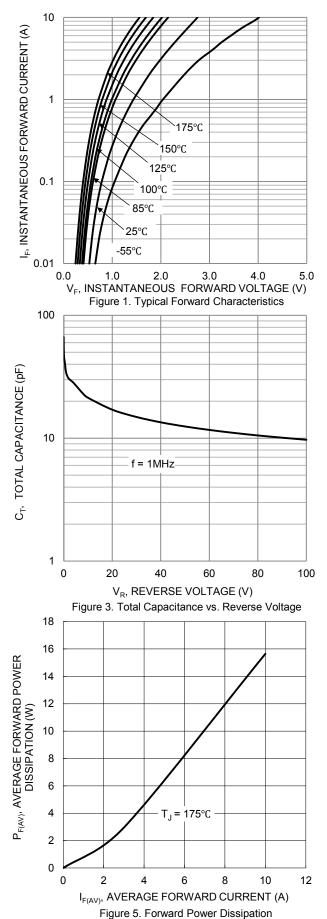
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

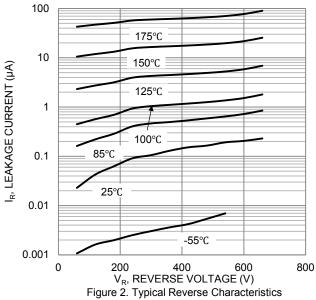
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse Voltage	V_{BR}	600	_	_	V	I _R = 50μA
		_	2.50	3.2	V	I _F = 8A, T _J = +25°C
Forward Voltage Drop	VF	_	1.70	_		I _F = 8A, T _J = +125°C
		_	1.55	_		I _F = 8A, T _J = +150°C
		_	0.4	20	μA	V _R = 600V, T _J = +25°C
Leakage Current (Note 7)	I_R	_	6.0	_		V _R = 600V, T _J = +125°C
		_	20	_		V _R = 600V, T _J = +150°C
Junction Capacitance	Ст	_	22	_	pF	V _R = 10V, f = 1MHz
		_	14	30		I _F = 0.5A, I _R = 1.0A, I _{RR} = 0.25A
			25	_		I _F = 1A, di/dt = 50A/μs,
			23		ns	$V_R = 30V, T_J = +25^{\circ}C$
		_	14	_		I _F = 1A, di/dt = 200A/μs,
Reverse Recovery Time	trr					V _R = 30V, T _J = +25°C
		_	26	_		$I_F = 8A$, $di/dt = 200A/\mu s$,
						V _R = 200V, T _J = +25°C
		— 60	60	60 —		I _F = 8A, di/dt = 200A/μs,
					V _R = 200V, T _J = +125°C	
		_	1.8	_	А	$I_F = 8A$, di/dt = 200A/ μ s,
Reverse Recovery Current (Note 7)	I _{RM}					V _R = 200V, T _J = +25°C
reverse resovery current (Note 1)	IKIVI	_	3.5			$I_F = 8A$, di/dt = 200A/ μ s,
			0.0			V _R = 200V, T _J = +125°C
	Q_{RR}	_	24	_	nC	I _F = 8A, di/dt = 200A/μs,
Reverse Recovery Charge						$V_R = 200V, T_J = +25^{\circ}C$
Thevelse recovery offarge		URR —	107	_		I _F = 8A, di/dt = 200A/μs,
						$V_R = 200V, T_J = +125^{\circ}C$

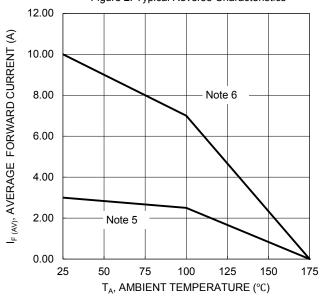
Note:

7. Short duration pulse test used to minimize self-heating effect.









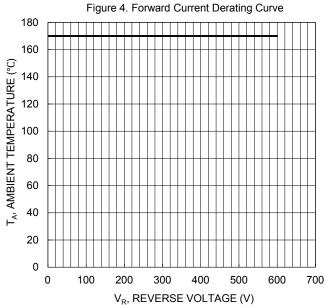
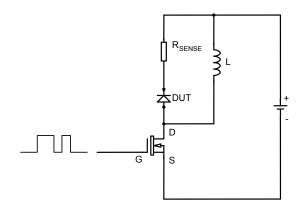


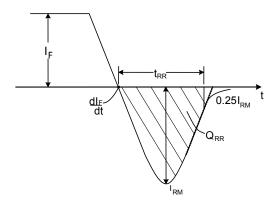
Figure 6. Operating Temperature Derating Curve



Test Circuit and Waveform Definitions







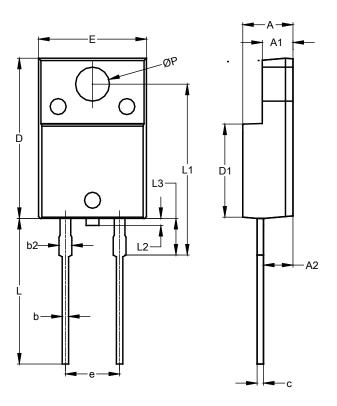
 $t_{\mbox{\scriptsize RR}}$ Waveform and Definitions



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

ITO220AC (Type E)



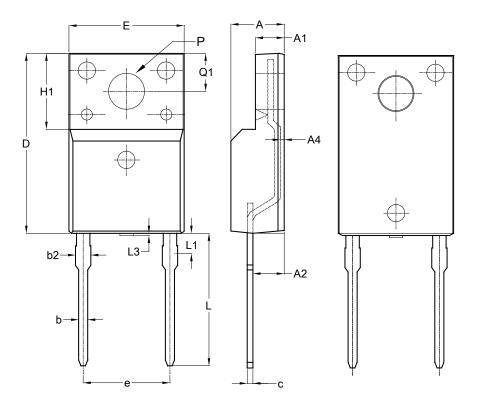
ITO220AC (Type E)				
Dim	Min	Max	Тур	
Α	4.36	4.77		
A 1	2.54	3.20	1	
A2	2.54	2.80	1	
b	0.55	0.75		
b2	1.20	1.70		
С	0.38	0.68	1	
D	14.50	15.50	-	
D1	8.38	8.89		
е	4.95	5.20	-	
Е	9.72	10.27	-	
L	13.46	14.22	-	
L1	15.80	17.20	-	
L2			1.30	
L3	3.55	4.35		
ØP	3.08	3.39	-	
All Dimensions in mm				



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

ITO220AC (Type HE) (Future Release)



ITO220AC (Type HE)					
Dim	Min	Max	Тур		
Α	4.50	4.90	4.70		
A1	2.34	2.74	2.54		
A2	2.56	2.96	2.76		
A4	0.30	0.60	0.45		
b	0.70	0.95	0.80		
b2	1.25	1.55	1.35		
С	0.45	0.65	0.50		
D	15.57	16.17	15.87		
е	4.83	5.33	5.08		
Е	9.96	10.36	10.16		
H1	6.70 REF				
L	12.68	13.28	12.98		
L1	3.03	3.43	3.23		
L3		0.20			
Q	3.15	3.45	3.30		
ØP	3.03	3.38	3.18		
All Dimensions in mm					

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